# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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Please read this notice before using the TAIYO YUDEN products.

#### **I** REMINDERS

Product information in this catalog is as of October 2017. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

- Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available.
- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this catalog are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and medical equipment classified as Class I or II by IMDRF. Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, disaster prevention equipment, medical equipment classified as Class III by IMDRF, highly public information network equipment including, without limitation, telephone exchange, and base station).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment\*, medical equipment classified as Class IV by IMDRF, nuclear control equipment, undersea equipment, military equipment).

\*Note: There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement.

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

#### Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

## LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES



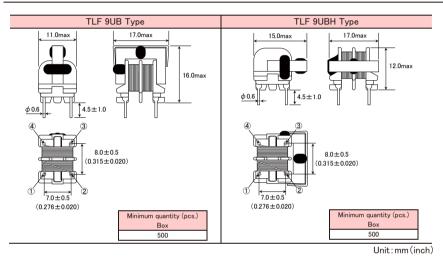
PARTS NUMB	ER				
T L F	△ 9 U B H 3 0 2 W K 1 ② ③ ④ ⑤ ⑥				
①Series name					
Code	Series name				
TLF	Common mode choke coil				
2 Dimensions of	core				
Code	Dimensions of core[mm]				
∆9	9				
③Shape					
Code	Shape				
UB∆	U core, vertically split wound				
UBH	U core, horizontally split wound				

\* Operating Temp.:-25~+105°C (Including self-generated heat)

 $\Delta = Blank space$ 

④Nominal inductance				
Code (example)	Nominal inductance[ $\mu$ H]			
302	3000			
203	20000			
⑤Inductance tole	erance			
Code	Inductance tolerance			
W	+100/-10%			
⑥Internal code				
Code	Internal code			
K1	Adhesive fixation			

STANDARD EXTERNAL DIMENSIONS / MINIMUM QUANTITY



#### PARTS NUMBER

Parts number	EHS	Number of lines	Nominal inductance [mH]	Inductance tolerance	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Rated voltage [V] (D.C.)	Insulation resistance [ΜΩ] (min.)
TLF 9UBH302W K1	RoHS	2	3.0	+100/-10%	1.5	0.40	50	100
TLF 9UB 302W K1	RoHS	2	3.0	+100/-10%	1.5	0.40	50	100
TLF 9UBH802W K1	RoHS	2	8.0	+100/-10%	3.0	0.30	50	100
TLF 9UB 802W K1	RoHS	2	8.0	+100/-10%	3.0	0.30	50	100
TLF 9UBH203W K1	RoHS	2	20.0	+100/-10%	6.5	0.18	50	100
TLF 9UB 203W K1	RoHS	2	20.0	+100/-10%	6.5	0.18	50	100

## LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES LEADED COMMON MODE CHOKE COILS FOR AC LINES

#### PACKAGING

#### $\textcircled{1}{Minimum Quantity}$

TLH/TLF Type	
Τ	Minimum Quantity[pcs]
Туре	Box
TLH10UA	
TLH10UB	1000
TLF10UAH	
TLF9UA	500
TLF9UB	500

## LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES, LEADED COMMON MODE CHOKE COILS FOR AC LINES

#### RELIABILITY DATA

1. Operating Tempe	rature Range	
Specified Value	TLH, TLF Type	$-25 \sim + 105^{\circ}C$
Test Method and Remarks	Including temperature rise due to self-generated heat.	

2. Storage temperature range		
Specified Value	TLH, TLF Type	-40~+ 85°℃

3. Rated current			
Specified Value	TLH, TLF Type		Within the specified range
Test Method and Remarks	TLH10U, TLF10UA TLF9UA, TLF9UB	: The maximum valu	ie of AC current within the temperature rise of $60^{\circ}$ C ie of AC current within the temperature rise of $45^{\circ}$ C ie of DC current within the temperature rise of $45^{\circ}$ C

4. Inductance			
Specified Value	TLH, TLF Type		Within the specified tolerance
Test Method and Remarks	TLF9U : Measuring equipment Measuring frequency Measuring voltage TLH、TLF (except TLF9U) : Measuring equipment Measuring frequency Measuring voltage	: 1kHz : 1Vrms	284A or its equivalent 284A or its equivalent

5. DC resistance			
Specified Value	TLH, TLF Type		Within the specified tolerance
Test Method and Remarks	Measuring equipment	: DC ohmmeter	

6. Terminal strength	n tensile force		
Specified Value	TLH, TLF Type		No abnormality
	TLH10UA, TLH10UB, TLF	9U : Apply the state	ed tensile force gradually in the direction to draw terminal.
	force [N]	duration [s]	
Test Method and Remarks	5	$30\pm5$	
	TLH10UAH, TLF (except	TLF9U): Apply the s	tated tensile force gradually in the direction to draw terminal.
	force [N]	duration [s]	
	10	$30\pm5$	

7. Insulation resista	nce between wires		
Specified Value	TLH, TLF Type		100M Ω min.
Test Method and Remarks	Applied voltage : 500VDC (TLH, TLF ( : 250VDC (TLF9UB) Duration : 60sec.		ccept TLF9UB))



8. Insulation resista	nce between wire an	d core	
Specified Value	TLH, TLF Type		100M $\Omega$ min.(except TLH, TLF10UAH Type)
Test Method and Remarks	TLF : Applied voltage : 500VDC (TLF (except : 250VDC (TLF9UB) Duration : 60 sec.		TLF9UB))

9. Withstanding : between wires			
Specified Value	TLH, TLF Type		No abnormality
Test Method and Remarks	Applied voltage Duration	: 500VDC (TLF9UB)	

10. Withstanding : between wires and core			
Specified Value	TLH, TLF Type		No abnormality(except TLH, TLF10UAH Type)
Test Method and Remarks	TLF : Applied voltage Duration	: 2000VAC (TLF (excep : 500VDC (TLF9UB) : 60sec.	t TLF9UB))

11. Rated voltage			
Specified Value	TLH, TLF Type		Within the specified range
Test Method and Remarks	TLH, TLF (except TLF9UB) TLF9UB	: 250VAC : 50VDC	

12. Resistance to vibration			
Specified Value	TLH, TLF Type		TLF9U : Inductance change : Within $\pm 5\%$ TLH, TLF (except TLF9U) : Appearance is no abnormality and within the specified range
Test Method and Remarks	TLH, TLF : According to JIS C60068-2-6.         Direction       : 2hrs each in X, Y and Z direction Total : 6hrs         Frequency range       : 10 to 55 to 10Hz (1 min.)         Amplitude       : 1.5mm (shall not exceed acceleration 196m/s²)         Mounting method       : soldering onto PC board         Recovery       : At least 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2hrs.		

13. Solderability	1			
Specified Value	TLH, TLF Type		At least 90% of terminal electrode is covered by new solder.	
Test Method and Remarks	TLH, TLF : Solder temperature Duration Immersion depth	: 235±0.5°C : 2±0.5sec. : Up to 1.5 to 2.0mm from PBC mounted level.		
	TLH, TLF : Solder temperature Duration Immersion depth	: 245±5℃ : 4±1sec. : Up to 1.0 to 1.5mm	n from PBC mounted level.	

14. Resistance to soldering heat

Specified Value	TLH, TLF Type		TLF9UA : Inductance change : Within $\pm 5\%$
Test Method and Remarks	TLH, TLF : Solder temperature Duration Immersion depth Recovery TLH, TLF :		n from PBC mounted level. covery under the standard condition after the removal from test chamber, followed by the :hin 2hrs.
	Solder temperature Duration Immersion depth		n from PBC mounted level.
	Recovery	: At least Thr of re- measurement wit	covery under the standard condition after the removal from test chamber, followed by the hin 2hrs.

15. Thermal shock			
Specified Value	TLH, TLF Type       TLF9UA : Inductance change : Within ±15%         TLH, TLF Type       TLH, TLF (except TLF9UA) : Withstanding voltage : No abnormality         Insulation resistance : No abnormality		
Test Method and Remarks	TLH, TLF : According to JIS C60068-2-14.         Conditions for 1 cycle         -25°C~+85°C, keep each 30min         Number of cycles : 10         Recovery       : At least 1hr of recovery under the standard condition after the removal from test chamber, followed by the measurement within 2 hrs.		

16. Damp heat			
Specified Value	TLH, TLF Type	TLF9UA : Inductance change : Within $\pm 15\%$ TLH, TLF (except TLF9UA) : Withstanding voltage : No abnormality Insulation resistance : No abnormality	
Test Method and Remarks	TLH, TLF : Temperature : $60\pm 2^{\circ}$ C : $40\pm 2^{\circ}$ C ( $\%$ except TL Humidity : $90 \sim 95\%$ RH Duration : 500 hrs Recovery : At least 1hr of recover	F9U) y under the standard removal from test chamber followed by the measurement within 2 hrs.	

17. Loading under damp heat			
Specified Value	TLH, TLF Type		Withstanding voltage : No abnormality Insulation resistance : No abnormality
Test Method and Remarks	TLH, TLF : Temperature Humidity Duration Applied voltage Recovery	: Apply the following s TLF9UA 2 TLF9UB 5	TLF9U ) current across windings (※except TLF9U ) specified voltage between windings. 250VAC 50VDC very under the standard removal from test chamber followed by the measurement within 2 hrs.

18. Low temperatu	re life test	
Specified Value	TLH, TLF Type	TLF9U : Inductance change : Within $\pm 15\%$ TLH, TLF (except TLF9U) : Withstanding voltage : No abnormality Insulation resistance : No abnormality
Test Method and Remarks	TLH, TLF : Temperature : -25±2°C : -40±2°C (※TLF•TLH ) Duration : 500 hrs Recovery : At least 1hr of recovery un	) nder the standard removal from test chamber followed by the measurement within 2 hrs.
19. High Temperati	ure life test	
Specified Value	TLH, TLF Type	TLF9U : Inductance change : Within $\pm 15\%$ TLH, TLF (except TLF9U) : Withstanding voltage : No abnormality Insulation resistance : No abnormality

: At least 1hr of recovery under the standard removal from test chamber followed by the measurement within 2 hrs.

TLH, TL F :

Duration Recovery

Temperature

: 105±3°C (※ TLF•TLH)

: 500 hrs

Test Method and

Remarks



## LEADED COMMON MODE CHOKE COILS FOR DC AND SIGNAL LINES, LEADED COMMON MODE CHOKE COILS FOR AC LINES

#### PRECAUTIONS

1. Circuit Design	
Precautions	<ul> <li>Operating environment</li> <li>The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems, measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance.</li> </ul>

2. PCB Design	
Precautions	<ul> <li>Design</li> <li>1. Please design insertion pitches as matching to that of leads of the component on PCBs.</li> </ul>
Technical considerations	<ul> <li>Design</li> <li>1. When Inductors are mounted onto a PC board, hole dimensions on the board should match the lead pitch of the component, if not, it will cause breakage of the terminals or cracking of terminal roots covered with resin as excess stress travels through the terminal legs.</li> </ul>

3. Soldering	
Precautions	<ul> <li>Wave soldering <ol> <li>Please refer to the specifications in the catalog for a wave soldering.</li> <li>Do not immerse the entire inductor in the flux during the soldering operation.</li> <li>Lead free soldering <ol> <li>When using products with lead free soldering, we request to use them after confirming of adhesion, temperature of resistance to soldering heat, etc. sufficiently.</li> </ol> </li> <li>Recommended conditions for using a soldering iron <ol> <li>Put the soldering iron on the land-pattern.</li> <li>Soldering iron's temperature - Below 350°C</li> <li>Duration - 3 seconds or less</li> <li>The soldering iron should not directly touch the product.</li> </ol> </li> </ol></li></ul>
Technical considerations	<ul> <li>Lead free soldering <ol> <li>If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.</li> <li>Recommended conditions for using a soldering iron</li> <li>If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.</li> </ol></li></ul>

4. Cleaning	
Precautions	<ul> <li>Cleaning conditions</li> <li>1. TLF type</li> <li>Please contact any of our offices for about a cleaning.</li> </ul>

5. Handling		
Precautions	<ul> <li>Handling <ol> <li>Keep the product away from all magnets and magnetic objects.</li> </ol> </li> <li>Mechanical considerations <ol> <li>Please do not give the product any excessive mechanical shocks.</li> <li>TLF type Please do not add any shock or power to a product in transportation. </li> <li>Packing <ol> <li>Please do not give the product any excessive mechanical shocks.</li> <li>In loading, please pay attention to handling indication mentioned in a packing box (a loading direction / number of maximum loading / fragile item).</li> </ol> </li> </ol></li></ul>	
Technical considerations	<ul> <li>Handling <ol> <li>There is a case that a characteristic varies with magnetic influence.</li> </ol> </li> <li>Mechanical considerations <ol> <li>There is a case to be damaged by a mechanical shock.</li> <li>TLF type <ol> <li>There is a case to be broken by a fall.</li> </ol> </li> <li>Packing <ol> <li>There is a case that a lead route turns at by a fall or an excessive shock.</li> </ol> </li> </ol></li></ul>	

This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/).

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6. Storage conditions	
Precautions	<ul> <li>Storage         <ol> <li>To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.             <ul> <li>Recommended conditions</li></ul></li></ol></li></ul>
Technical considerations	<ul> <li>Storage</li> <li>Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.</li> </ul>